

SEMICONDUCTOR TM

# FQD2N60 / FQU2N60

# 600V N-Channel MOSFET

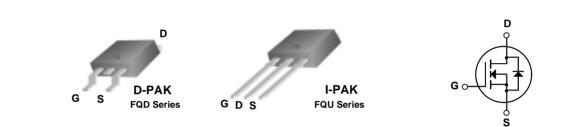
### **General Description**

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switch mode power supply.

#### Features

- 2.0A, 600V,  $R_{DS(on)} = 4.7\Omega @V_{GS} = 10 V$  Low gate charge ( typical 9.0 nC)
- Low Crss (typical 5.0 pF)
- · Fast switching
- 100% avalanche tested
- Improved dv/dt capability



# Absolute Maximum Ratings T<sub>c</sub> = 25°C unless otherwise noted

Symbol	Parameter		FQD2N60 / FQU2N60	Units	
V <sub>DSS</sub>	Drain-Source Voltage		600	V	
I <sub>D</sub>	Drain Current - Continuous ( $T_C = 25^{\circ}C$ ) - Continuous ( $T_C = 100^{\circ}C$ )		2.0	А	
			1.26	А	
I <sub>DM</sub>	Drain Current - Pulsed	(Note 1)	8.0	А	
V <sub>GSS</sub>	Gate-Source Voltage		± 30	V	
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)		140	mJ	
I <sub>AR</sub>	Avalanche Current (Note 1)		2.0	А	
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1)		4.5	mJ	
dv/dt	Peak Diode Recovery dv/dt (Note 3)		4.5	V/ns	
PD	Power Dissipation ( $T_A = 25^{\circ}C$ ) *		2.5	W	
	Power Dissipation ( $T_C = 25^{\circ}C$ )		45	W	
	- Derate above 25°C	0.36	W/°C		
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +150	°C	
TL	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C	

## **Thermal Characteristics**

Symbol	Parameter	Тур	Max	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		2.78	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient *		50	°C/W
$R_{\thetaJA}$	Thermal Resistance, Junction-to-Ambient		110	°C/W

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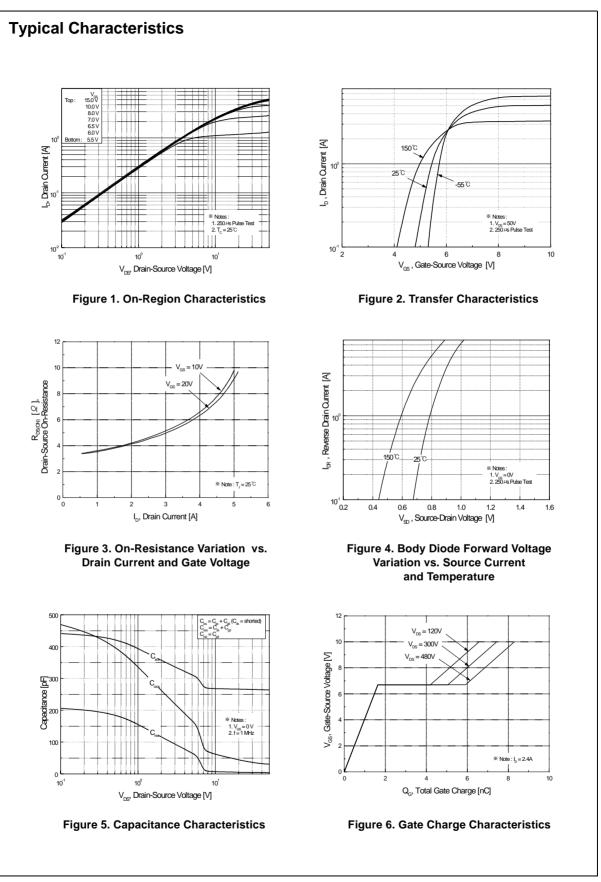
Symbol	Parameter	Test Conditions		Min	Тур	Max	Units
Off Cha	aracteristics						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_{D} = 250 \mu A$		600			V
ΔBV <sub>DSS</sub> / ΔTj	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu A$ , Referenced to	o 25°C		0.4		V/°C
DSS		V <sub>DS</sub> = 600 V, V <sub>GS</sub> = 0 V				10	μA
	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 480 V, T <sub>C</sub> = 125°C			100	μA	
GSSF	Gate-Body Leakage Current, Forward	$V_{GS} = 30 \text{ V}, V_{DS} = 0 \text{ V}$				100	nA
GSSR	Gate-Body Leakage Current, Reverse	$V_{GS} = -30 \text{ V}, V_{DS} = 0 \text{ V}$				-100	nA
On Cha	racteristics						
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$		3.0		5.0	V
R <sub>DS(on)</sub>	Static Drain-Source On-Resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 1.0 \text{ A}$			3.7	4.7	Ω
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 50 V, I <sub>D</sub> = 1.0 A	(Note 4)		2.25		S
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V, f = 1.0 MHz			40 5	50 7	pF pF
C <sub>rss</sub>	Reverse Transfer Capacitance			5	7	pF	
Switch	ing Characteristics						
t <sub>d(on)</sub>	Turn-On Delay Time	V <sub>DD</sub> = 300 V, I <sub>D</sub> = 2.4 A,			10	30	ns
t <sub>r</sub>	Turn-On Rise Time	$R_{G} = 25 \Omega$			25	60	ns
t <sub>d(off)</sub>	Turn-Off Delay Time				20	50	ns
-	Turn-Off Fall Time	(1	Note 4, 5)		25	60	ns
t <sub>f</sub>	Total Gate Charge	V <sub>DS</sub> = 480 V, I <sub>D</sub> = 2.4 A,			9.0	11	nC
	Tetal Cate Charge	$V_{GS} = 10 \text{ V}$			1.6		nC
Q <sub>g</sub>	Gate-Source Charge	V <sub>GS</sub> = 10 V					nC
Q <sub>g</sub> Q <sub>gs</sub>	Gate-Source Charge		Note 4 5)		10		nc
Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub>		(1	Note 4, 5)		4.3		
Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub> Drain-S	Gate-Source Charge Gate-Drain Charge	nd Maximum Ratings			4.3	2.0	A
Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub> Drain-S	Gate-Source Charge Gate-Drain Charge	nd Maximum Ratings					A
Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub> Drain-S	Gate-Source Charge Gate-Drain Charge Gource Diode Characteristics an Maximum Continuous Drain-Source Dio	nd Maximum Ratings				2.0	
$t_{f}$ $Q_{g}$ $Q_{gs}$ $Q_{gd}$ <b>Drain-S</b> $I_{S}$ $I_{SM}$ $V_{SD}$ $t_{rr}$	Gate-Source Charge Gate-Drain Charge Source Diode Characteristics an Maximum Continuous Drain-Source Diode Maximum Pulsed Drain-Source Diode F	nd Maximum Ratings ade Forward Current Forward Current				2.0 8.0	А

Notes: 1. Repetitive Rating : Pulse width limited by maximum junction temperature 2. L = 64mH, I<sub>AS</sub> = 2.0A, V<sub>DD</sub> = 50V, R<sub>G</sub> = 25  $\Omega$ , Starting T<sub>J</sub> = 25°C 3. I<sub>SD</sub>  $\leq$  2.4A, di/dt  $\leq$  200A/µs, V<sub>DD</sub>  $\leq$  BV<sub>DSS</sub> Starting T<sub>J</sub> = 25°C 4. Pulse Test : Pulse width  $\leq$  300µs, Duty cycle  $\leq$  2% 5. Essentially independent of operating temperature

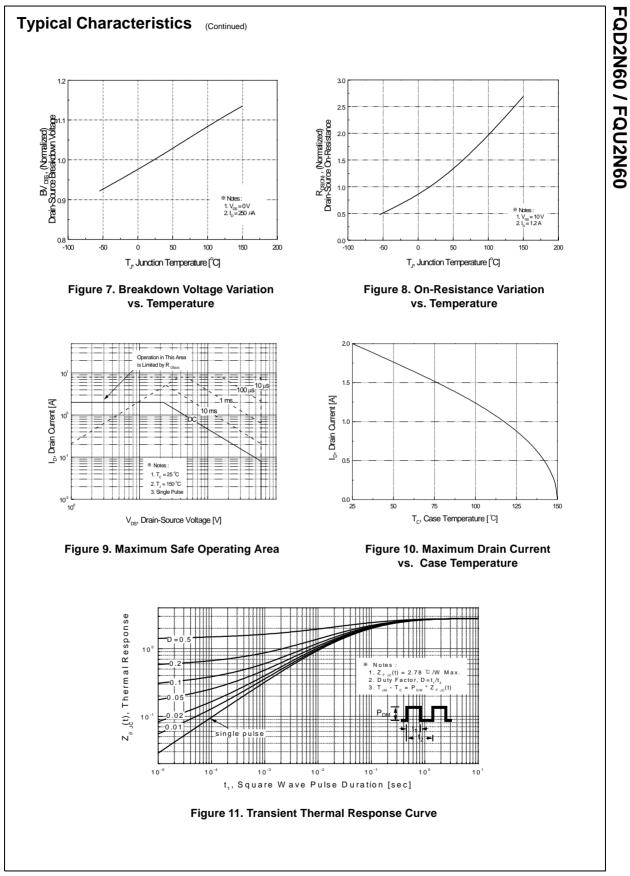
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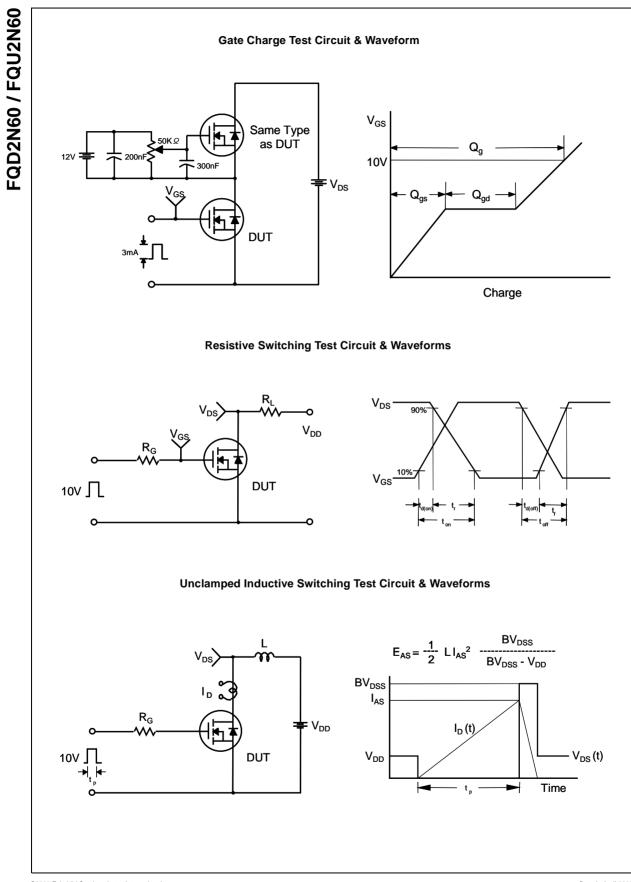
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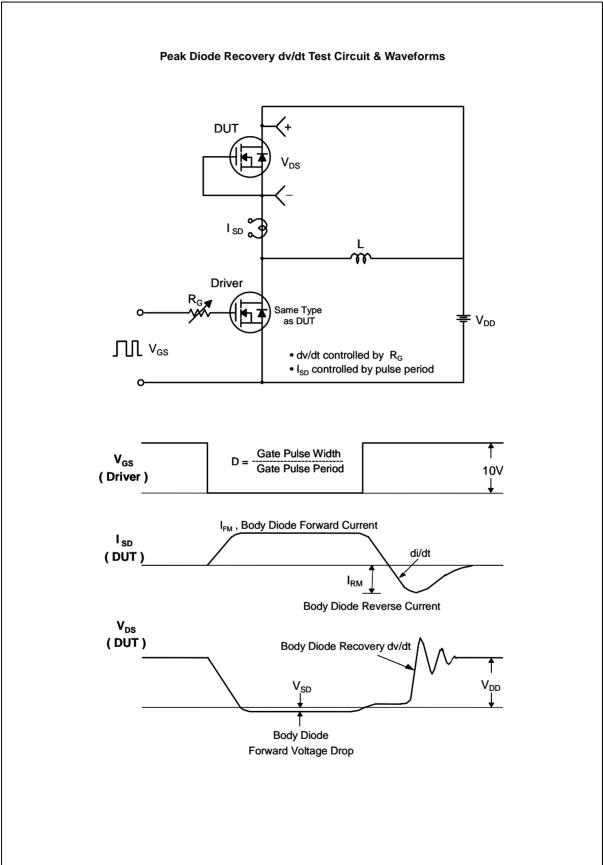
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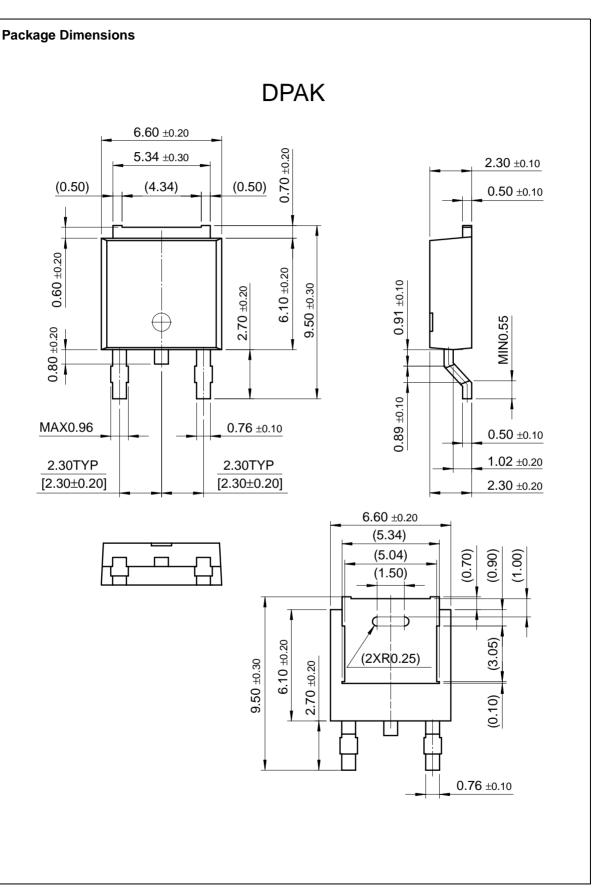


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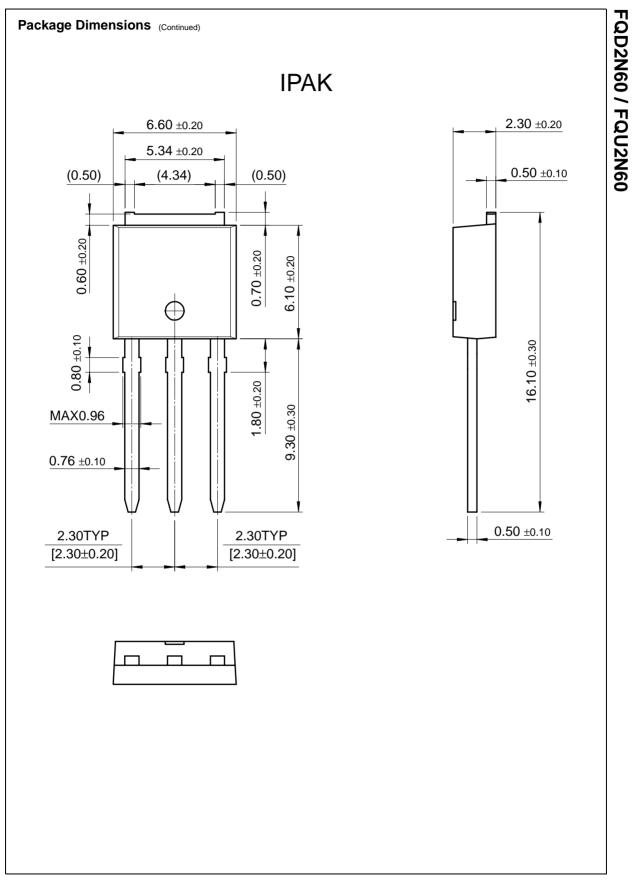


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#### **Definition of Terms**

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
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my Fairchild company	Features		

- 2.0 A, 600 V.  $R_{DS(ON)} = 4.7 \Omega @ V_{GS}$ = 10 V Low gate charge (typical 9.0 nC).Low Crss (typical 5.0 pF)
- Fast switching
- 100% avalanche tested
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Product status/pricing/packaging

Product	Product status	Pricing*	Package type	Leads	Packing method
FQD2N60TF	Full Production	\$0.56	TO-252(DPAK)	2	TAPE REEL

FQD2N60TM	Full Production	\$0.56	TO-252(DPAK)	2	TAPE REEL
* 1,000 piece Budg	etary Pricing				

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